

TC74VHC273F, TC74VHC273FW, TC74VHC273FT, TC74VHC273FK

Octal D-Type Flip-Flop with Clear

The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the $\overline{\text{CLR}}$ input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

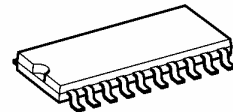
- High speed: $f_{\text{max}} = 165 \text{ MHz}$ (typ.) at $V_{\text{CC}} = 5 \text{ V}$
- Low power dissipation: $I_{\text{CC}} = 4 \mu\text{A}$ (max) at $T_a = 25^\circ\text{C}$
- High noise immunity: $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$ (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: $t_{\text{PLH}} \approx t_{\text{PHL}}$
- Wide operating voltage range: $V_{\text{CC (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: $V_{\text{OLP}} = 0.9 \text{ V}$ (max)
- Pin and function compatible with 74ALS273

Weight

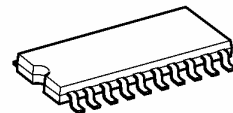
SOP20-P-300-1.27A	: 0.22 g (typ.)
SOP20-P-300-1.27	: 0.22 g (typ.)
SOL20-P-300-1.27	: 0.46 g (typ.)
TSSOP20-P-0044-0.65A	: 0.08 g (typ.)
VSSOP20-P-0030-0.50	: 0.03 g (typ.)

Note: xxxFW (JEDEC SOP) is not available in Japan.

TC74VHC273F

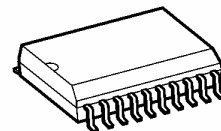


SOP20-P-300-1.27A



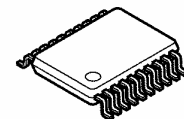
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TC74VHC273FW



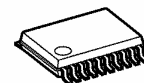
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TC74VHC273FT



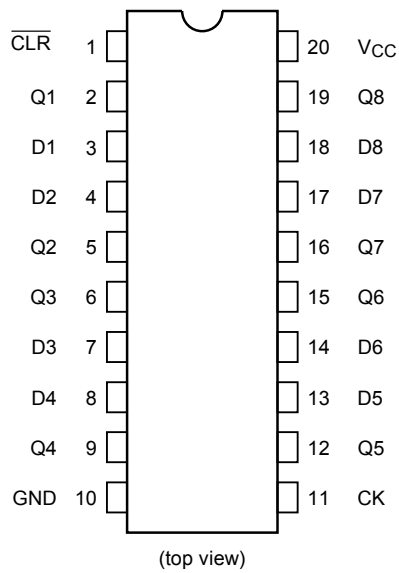
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TC74VHC273FK

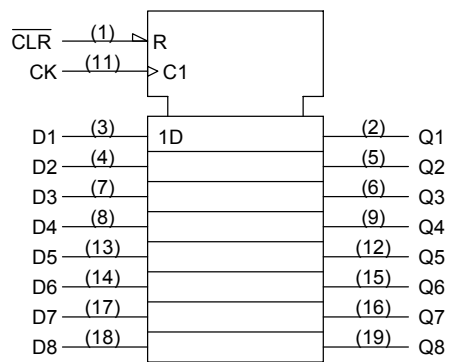


VSSOP20-P-0030-0.50

Pin Assignment



IEC Logic Symbol

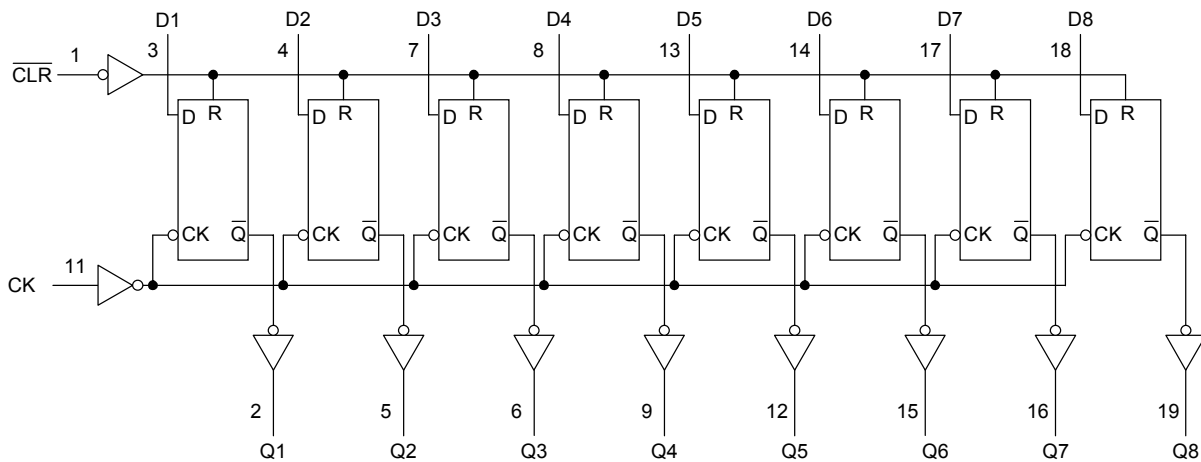


Truth Table

Inputs			Output	Function
CLR	D	CK	Q	
L	X	X	L	Clear
H	L		L	—
H	H		H	—
H	X		Q _n	No Change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5 to 7.0	V
DC input voltage	V_{IN}	-0.5 to 7.0	V
DC output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}	-20	mA
Output diode current	I_{OK}	± 20	mA
DC output current	I_{OUT}	± 25	mA
DC V_{CC} /ground current	I_{CC}	± 75	mA
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Recommended Operating Conditions (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 5.5	V
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 ($V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ($V_{CC} = 5 \pm 0.5$ V)	ns/V

Note: The recommended operating conditions are required to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C				Ta = −40 to 85°C		Unit
				V _{CC} (V)	Min	Typ.	Max	Min	Max	
High-level input voltage	V _{IH}	—		2.0 3.0 to 5.5	1.50 V _{CC} × 0.7	— —	— —	1.50 V _{CC} × 0.7	— —	V
Low-level input voltage	V _{IL}	—		2.0 3.0 to 5.5	— —	— —	0.50 V _{CC} × 0.3	— —	0.50 V _{CC} × 0.3	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = −50 μA	2.0	1.9	2.0	—	1.9	—	V
				3.0	2.9	3.0	—	2.9	—	
				4.5	4.4	4.5	—	4.4	—	
			I _{OH} = −4 mA	3.0	2.58	—	—	2.48	—	
I _{OH} = −8 mA	4.5	3.94	—	—	3.80	—				
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	—	0.0	0.1	—	0.1	V
				3.0	—	0.0	0.1	—	0.1	
				4.5	—	0.0	0.1	—	0.1	
			I _{OL} = 4 mA	3.0	—	—	0.36	—	0.44	
I _{OL} = 8 mA	4.5	—	—	0.36	—	0.44				
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	—	—	4.0	—	40.0	μA

Timing Requirements (input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
				V _{CC} (V)	Typ.	Limit	
Minimum pulse width (CK)	t _w (L)	—	—	3.3 ± 0.3	—	5.5	6.5
	t _w (H)			5.0 ± 0.5	—	5.0	5.0
Minimum pulse width ($\overline{\text{CLR}}$)	t _w (L)	—	—	3.3 ± 0.3	—	5.0	6.0
				5.0 ± 0.5	—	5.0	5.0
Minimum set-up time	t _s	—	—	3.3 ± 0.3	—	5.5	6.5
				5.0 ± 0.5	—	4.5	4.5
Minimum hold time	t _h	—	—	3.3 ± 0.3	—	1.0	1.0
				5.0 ± 0.5	—	1.0	1.0
Minimum removal time ($\overline{\text{CLR}}$)	t _{rem}	—	—	3.3 ± 0.3	—	2.5	2.5
				5.0 ± 0.5	—	2.0	2.0

AC Characteristics (input: $t_r = t_f = 3\text{ ns}$)

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
			V _{CC} (V)	C _L (pF)	Min	Typ.	Max	Min	Max	
Propagation delay time (CK-Q)	t _{pLH} t _{pHL}	—	3.3 ± 0.3	15	—	8.7	13.6	1.0	16.0	ns
				50	—	11.2	17.1	1.0	19.5	
			5.0 ± 0.5	15	—	5.8	9.0	1.0	10.5	
				50	—	7.3	11.0	1.0	12.5	
Propagation delay time ($\overline{\text{CLR}}$ -Q)	t _{pHL}	—	3.3 ± 0.3	15	—	8.9	13.6	1.0	16.0	ns
				50	—	11.4	17.1	1.0	19.5	
			5.0 ± 0.5	15	—	5.2	8.5	1.0	10.0	
				50	—	6.7	10.5	1.0	12.0	
Maximum clock frequency	f _{max}	—	3.3 ± 0.3	15	75	120	—	65	—	MHz
				50	50	75	—	45	—	
			5.0 ± 0.5	15	120	165	—	100	—	
				50	80	110	—	70	—	
Output to output skew	t _{osLH} t _{osHL}	(Note 1)	3.3 ± 0.3	50	—	—	1.5	—	1.5	ns
	5.0 ± 0.5		50	—	—	1.0	—	1.0		
Input capacitance	C _{IN}	—			—	4	10	—	10	pF
Power dissipation capacitance	C _{PD}	(Note 2)			—	31	—	—	—	pF

Note 1: Parameter guaranteed by design.

$$t_{\text{osLH}} = |t_{pLHm} - t_{pLHn}|, t_{\text{osHL}} = |t_{pHLm} - t_{pHLn}|$$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{\text{CC (opr)}} = C_{\text{PD}} \cdot V_{\text{CC}} \cdot f_{\text{IN}} + I_{\text{CC}}/8 \text{ (per bit)}$$

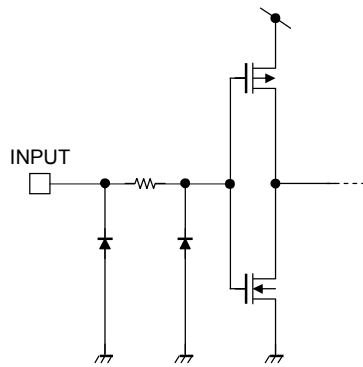
And the total C_{PD} when n pcs. of flip flop operate can be gained by the following equation:

$$C_{\text{PD (total)}} = 22 + 9 \cdot n$$

Noise Characteristics (input: $t_r = t_f = 3\text{ ns}$) (Note)

Characteristics	Symbol	Test Condition	Ta = 25°C			Unit
			V _{CC} (V)	Typ.	Max	
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.5 (0.6)	0.8 (0.9)	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.5 (-0.6)	-0.8 (-0.9)	V
Minimum high level dynamic input voltage	V _{IHD}	C _L = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage	V _{ILD}	C _L = 50 pF	5.0	—	1.5	V

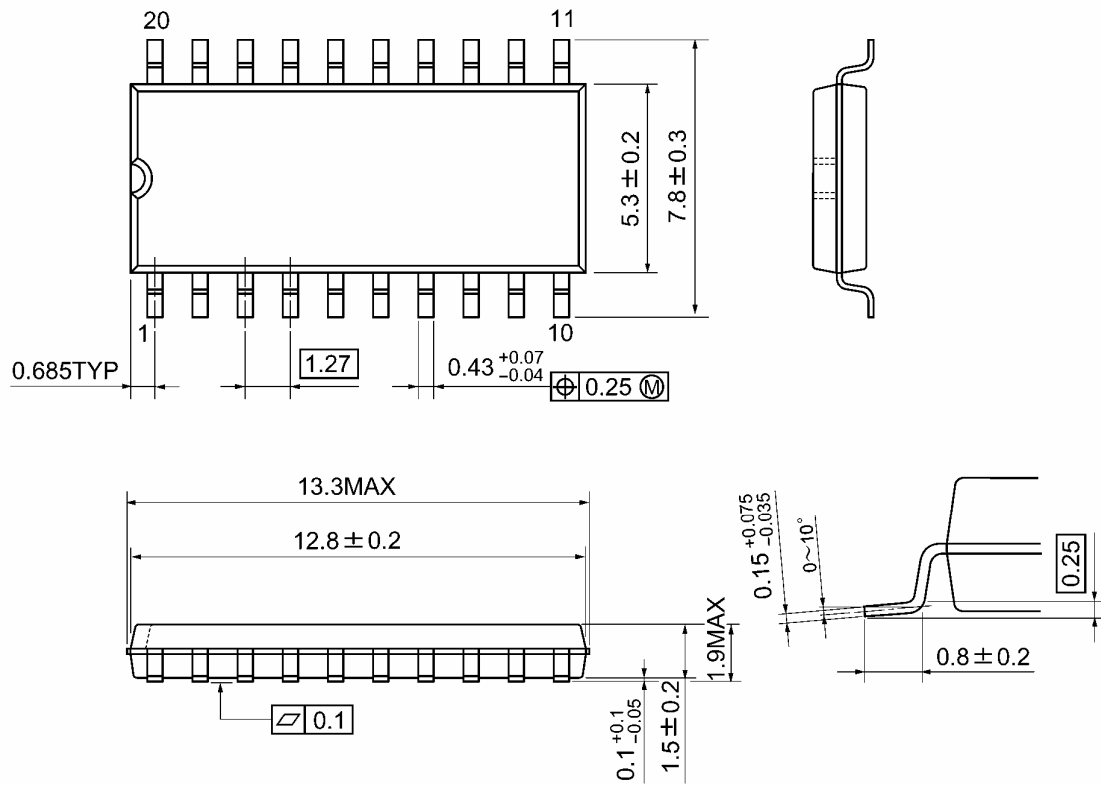
Note: The value in () only applies to JEDEC SOP (FW) devices.

Input Equivalent Circuit

Package Dimensions

SOP20-P-300-1.27A

Unit: mm

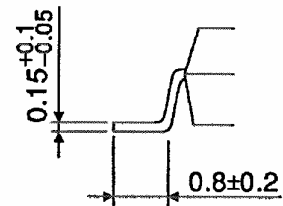
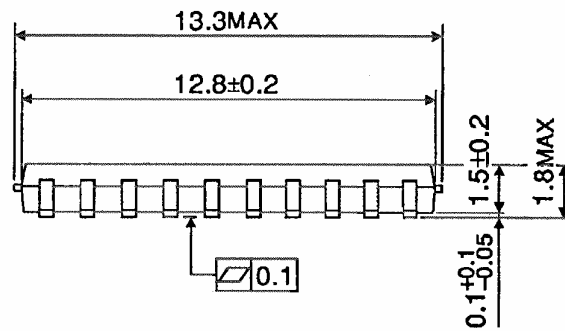
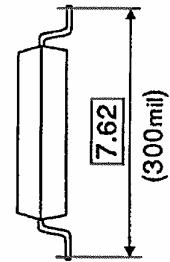


Weight: 0.22 g (typ.)

SOP20-P-300-1.27

Diagram illustrating the mechanical dimensions of the 20-pin package. The package is shown with pins numbered 1 through 20. Key dimensions include:

- Pin 1 to Pin 20 distance: 0.685 TYP
- Pin 1 to Pin 10 distance: 1.27
- Pin 10 to Pin 20 distance: 0.43 ± 0.1
- Pin 10 to Pin 11 distance: 0.25 (M)
- Pin 11 to Pin 20 distance: 5.3 ± 0.2
- Pin 11 to Pin 1 distance distance: 7.8 ± 0.3

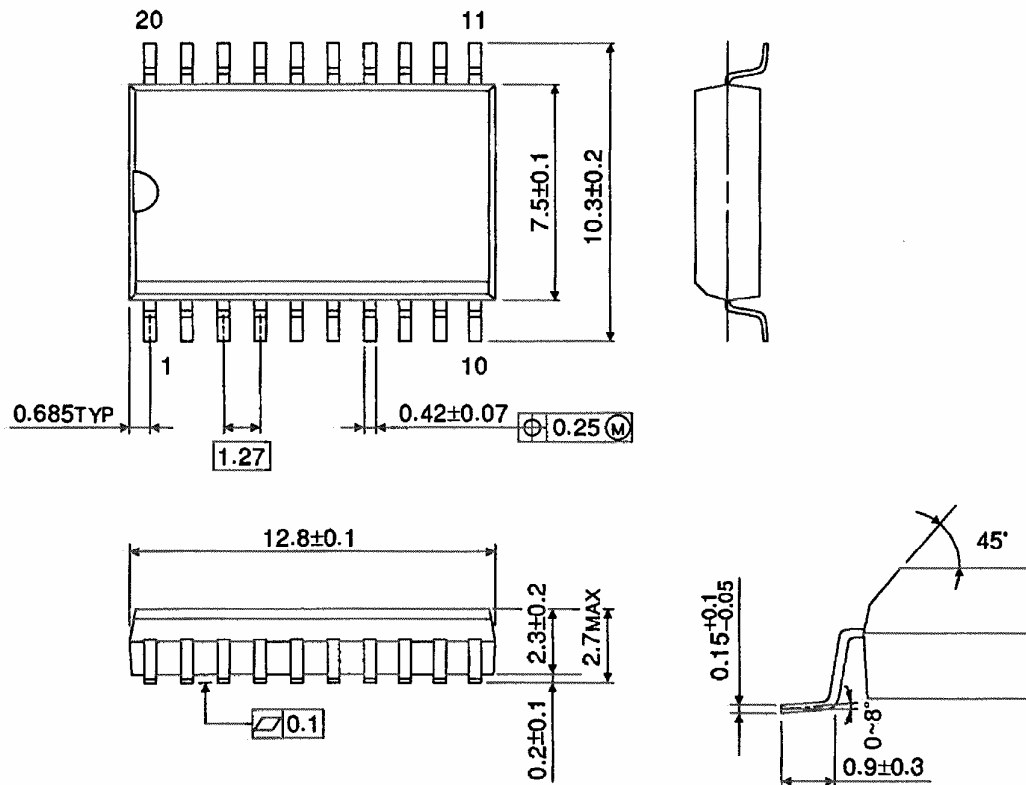


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Package Dimensions (Note)

SOL20-P-300-1.27

Unit : mm



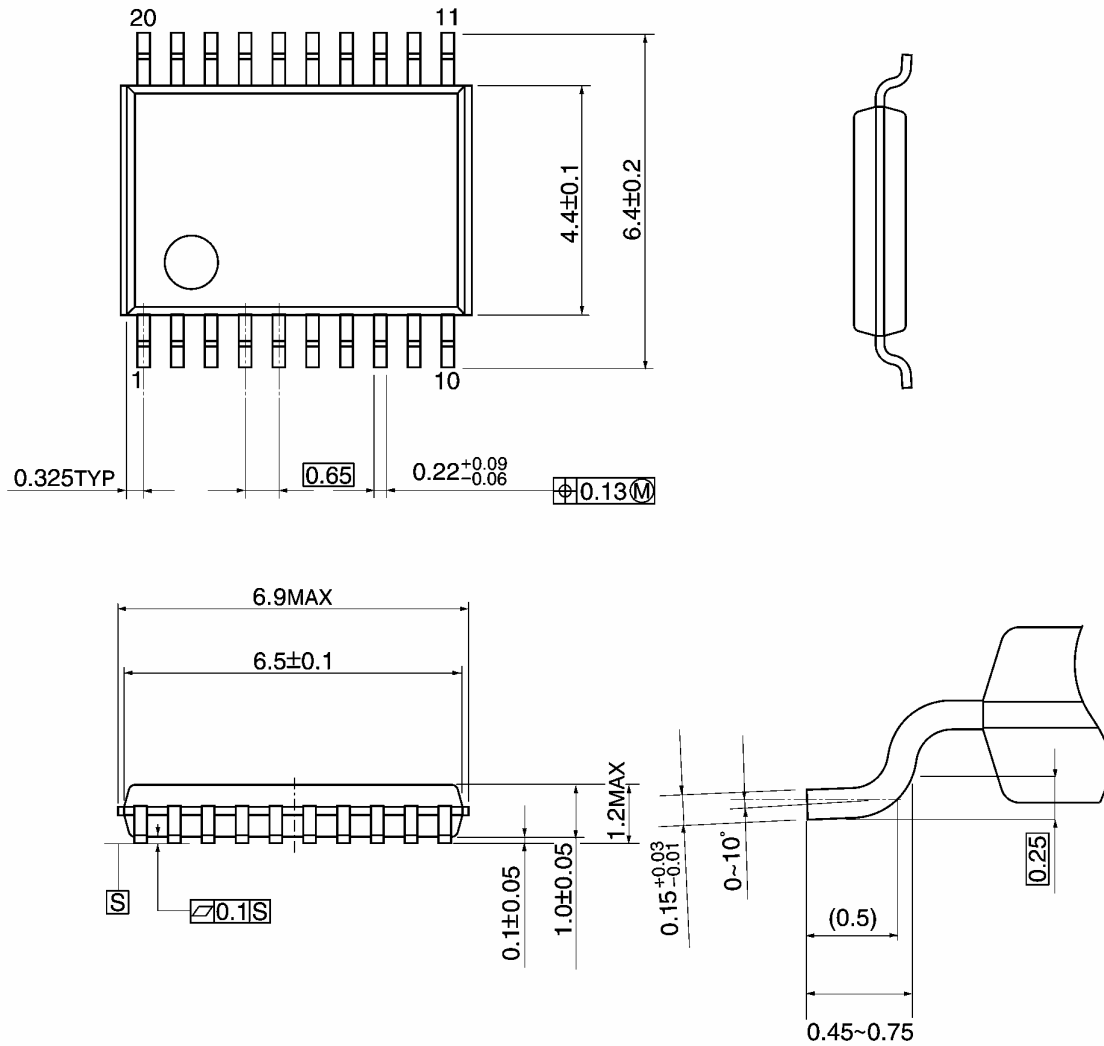
Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

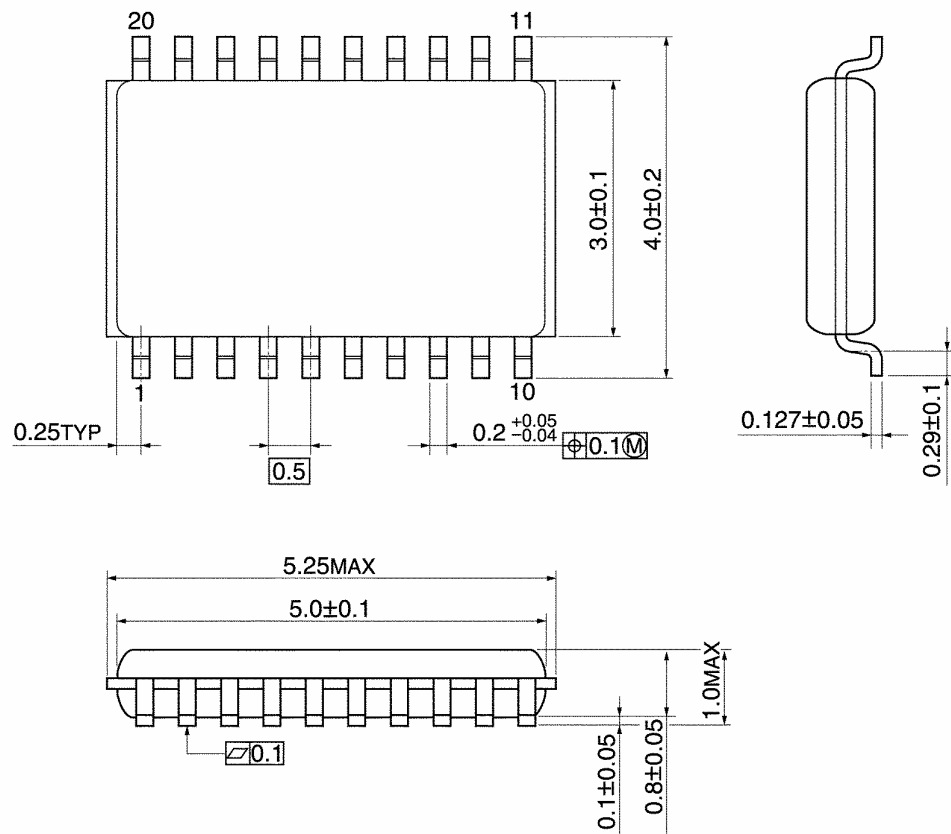


Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

Note: Lead (Pb)-Free Packages

SOP20-P-300-1.27A TSSOP20-P-0044-0.65A VSSOP20-P-0030-0.50

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